

Notice of References Cited	Application/Control No. 10/598,124		Applicant(s)/Patent Under Reexamination SAKAMOTO ET AL.	
	Examiner YOSHITOSHI TAKEUCHI		Art Unit 1726	Page 1 of 1

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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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*	B	US-3,359,132	12-1967	WITTMANN ALBIN E	228/125
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	M	US-			

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NON-PATENT DOCUMENTS

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	V	Niedzielski, Neopentyl Polyol Ester Lubricants—Bulk Property Optimization, 54-58 Ind. Eng. Chem., Prod. Res. Dev. 15 (1976)
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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.